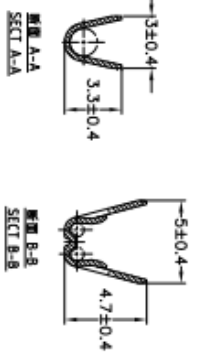
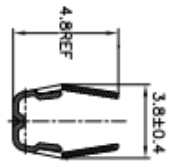
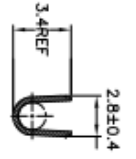
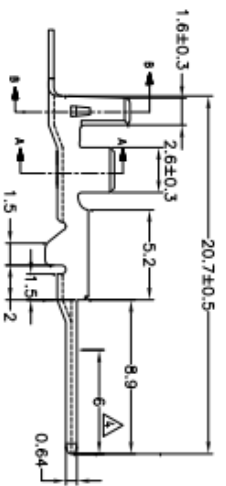




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- 1. 製造規格: 108-5231, 108-5264
  - 2. 検査標準: 173631 様
  - 3. 圧着規格: TL-5092
  - △ 部分金メッキ: 他社ニテマカセ
- 1. SPEC: 108-5231, 108-5264
  - 2. RECEPTACLE CONTACT: 173631 etc
  - 3. APPLICATION SPECIFICATION: TL-5092
  - △ SELECTIVE GOLD PLATING, REMAINDER NICKEL PLATING

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CHK: TK	CHK: TK

DESIGNER: YN	DATE: 18/03/2018
DRAWN: TK	DATE: 18/03/2018
CHECKED: YN	DATE: 18/03/2018
APPROVED: YN	DATE: 18/03/2018

SEE DRAWING 173645-5	SEE DRAWING 173645-5
173645-3 SELECTIVE GOLD	173645-3 PHOS BR0 1.332
173645-2 PRE-TINNED	173645-2 PHOS BR0 1.332
173645-1	173645-1 PHOS BR0 1.332



070 SERIES TAB CONTACT

300779

SCALE 5:1